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Shahan Islam

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Hisamitsu Shizuno et al.

Group Art Unit: 3729

Application No.: 09/784,999

Examiner: Alan M. Boswell

Filed: February 15, 2001

Docket No.: 3158/FLK

Title: MULTILAYER DISPLACEMENT ELEMENT AND METHOD FOR  
MANUFACTURING SAME

Honorable Commissioner for Patents  
Washington, D.C. 20231

March 10, 2003

**RECEIVED**  
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TECHNOLOGY CENTER R3700

AMENDMENT

Sir:

In response to the Examiner's Restriction Requirement dated February 11, 2003, please amend the above-identified application as follows:

In the Claims:

Please amend claim 8 as follows:

**BEST AVAILABLE COPY**

8. (Amended) A method for manufacturing the multilayer displacement element of claim 1, comprising the steps of:

(a) forming ceramic green sheets that are composed of electrostrictive ceramic